TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (U-MOS IV)

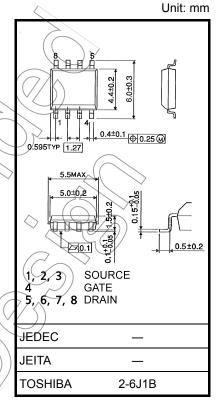
# **TPC8026**

Lithium Ion Battery Applications
Portable Equipment Applications
Notebook PC Applications

- Small footprint due to small and thin package
- Low drain-source ON resistance:  $RDS(ON) = 5.1 \text{ m}\Omega \text{ (typ.)}$
- High forward transfer admittance:  $|Y_{fs}| = 30 \text{ S (typ.)}$
- Low leakage current:  $IDSS = 10 \mu A (max) (VDS = 30 V)$
- Enhancement mode:  $V_{th} = 1.3 \text{ to } 2.5 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA)}$

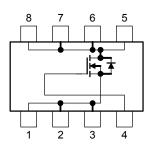
### Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		$V_{DSS}$	30	V
Drain-gate voltage ( $R_{GS} = 20 \text{ k}\Omega$ )		$V_{DGR}$	30	V
Gate-source voltage		V <sub>GSS</sub>	±20	V
Drain current	DC (Note 1)	_D (	13	<\A
	Pulse (Note 1)	I <sub>DP</sub>	52	\ <u>A</u>
Drain power dissipation	on $(t = 10 s)$ (Note 2a)	DD C	1.9	w
Drain power dissipation	on (t = 10 s) (Note 2b)	PD	1.0	W
Single pulse avalanch	ne energy (Note 3)	EAS	(44/5)	mJ
Avalanche current		I <sub>AR</sub>	13	Α
Repetitive avalanche energy (Note 2a) (Note 4)		EAR	0.048	mJ
Channel temperature		T <sub>ch</sub>	150	°C
Storage temperature range		√T <sub>stg</sub>	-55 to 150	°C



Weight: 0.08 g (typ.)

#### **Circuit Configuration**



Note 1, Note 2, Note 3 and Note 4: See the next page.

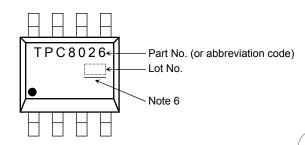
Using continuously under heavy loads (e.g., the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

This transistor is an electrostatic-sensitive device. Please handle with caution.

#### **Thermal Characteristics**

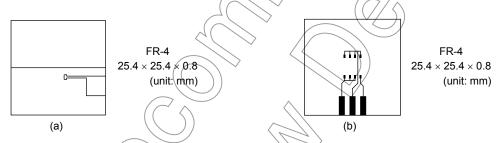
Characteristics	Symbol	Max	Unit	
Thermal resistance, channel to ambient $(t=10 \; s) \eqno(Note \; 2a)$	R <sub>th (ch-a)</sub>	65.8	°C/W	
Thermal resistance, channel to ambient (t = 10 s) (Note 2b)	R <sub>th (ch-a)</sub>	125	°C/W	

### Marking (Note 5)



Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: (a) Device mounted on a glass-epoxy board (b) Device mounted on a glass-epoxy board (b)



Note 3:  $V_{DD} = 24 \text{ V}$ ,  $T_{ch} = 25^{\circ}\text{C}$  (initial), L = 0.2 mH,  $I_{AR} = 13 \text{ A}$ 

Note 4: Repetitive rating: pulse width limited by max channel temperature

Note 5: • on the lower left of the marking indicates Pin 1.

\* Weekly code: (Three digits)

Week of manufacture
(01 for first week of year, continuing up to 52 or 53)

Year of manufacture
(The last digit of the calendar year)

Note 6: A line under a Lot No. identifies the indication of product Labels.

Not underlined: [[Pb]]/INCLUDES > MCV

Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

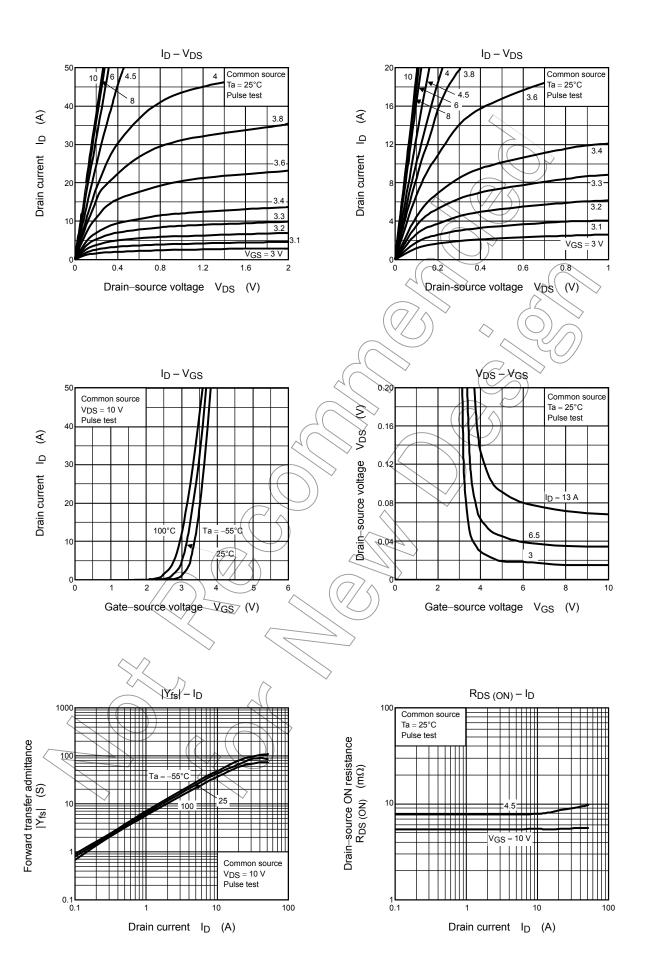
## **Electrical Characteristics (Ta = 25°C)**

Cha	aracteristics	Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage cur	rent	I <sub>GSS</sub>	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±100	nA	
Drain cut-OFF cu	ırrent	I <sub>DSS</sub>	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V	_	_	10	μА	
Drain-source breakdown voltage		V (BR) DSS	$I_D = 10 \text{ mA}, V_{GS} = 0 \text{ V}$	30	_	_	V	
		V (BR) DSX	$I_D = 10 \text{ mA}, V_{GS} = -20 \text{ V}$	10		_		
Gate threshold vo	oltage	$V_{th}$	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$	1.3	) >_	2.5	V	
Drain-source ON resistance		R <sub>DS (ON)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 6.5 \text{ A}$	)   	7.5	10	- mΩ	
			$V_{GS} = 10 \text{ V}, I_D = 6.5 \text{ A}$	$\rightarrow$	5.1	6.6		
Forward transfer	admittance	Y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 6.5 A	15	30	_	S	
Input capacitance		C <sub>iss</sub>		_	1800	_		
Reverse transfer capacitance		C <sub>rss</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	370	_	pF	
Output capacitance		Coss			570	$\nearrow$	_	
Switching time	Rise time	t <sub>r</sub>	10 V	-(	15	> _		
	Turn-ON time	t <sub>on</sub>	V <sub>GS</sub> 10 V   I <sub>D</sub> ± 6.5 A   O V <sub>OUT</sub>   G   G   G   G   G   G   G   G   G		28	_	20	
	Fall time	t <sub>f</sub>	R <sub>L</sub> = 2.5	$(\mathcal{T})$	21	_	ns	
	Turn-OFF time	t <sub>off</sub>	V <sub>DD</sub> ≃ 15 V Duty ≤ 1%, t <sub>w</sub> = 10 µs	) —	54	_		
Total gate charge (gate-source plus		Qg		_	42	_		
Gate-source charge 1		Q <sub>gs1</sub>	$V_{DD} \simeq 24 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 13 \text{ A}$	_	6.5	_	nC	
Gate-drain ("miller") charge		Qgd		_	14	_		

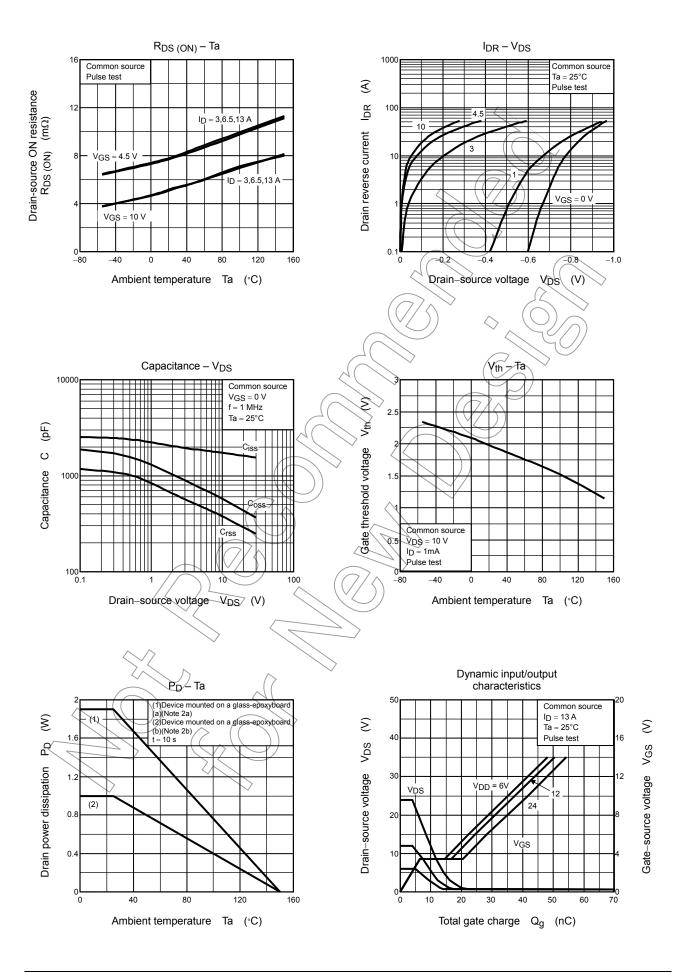
# Source-Drain Ratings and Characteristics (Ta = 25°C)

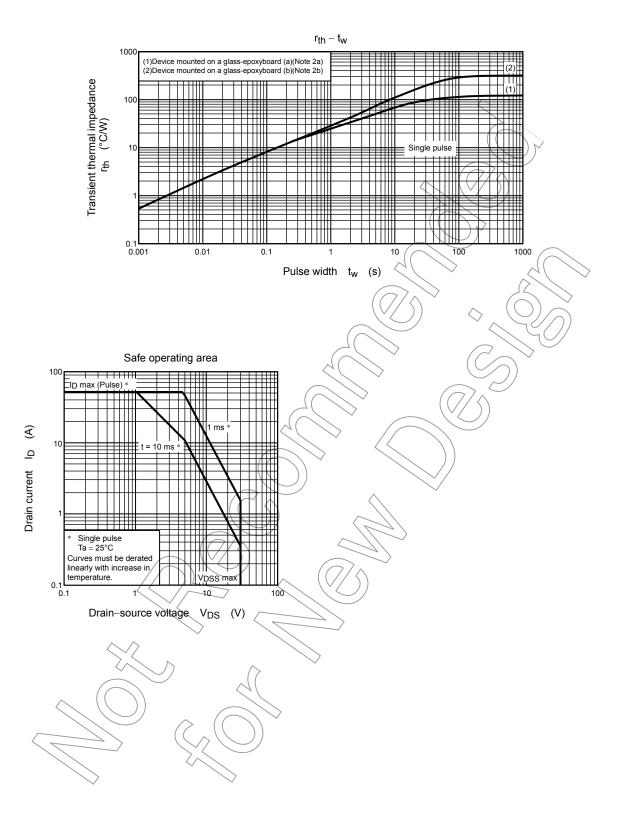
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current Pulse (Note-1)	I <sub>DRP</sub>	// —	_	_	52	Α
Forward voltage (diode)	VDSE IDR = 13	6 A, V <sub>GS</sub> = 0 V	_	_	-1.2	V





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